

# 二重増幅率制御型多層THGEMの 高強度重イオンビームに対する性能評価

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# Outline

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1. Introduction
  1. CNS Active target
  2. “Dual Gain control” & “Multi-layer structure” of THGEM
2. Performance evaluation for the THGEM
  1. Gain curve and resolutions with the high intensity beam
  2. Bending deflection
3. Summary

# CNS Active target “CAT”

## Gas Active Target with Box type GEM-TPC

Side View of CAT-S

GEMs and  
Readout Pad

Beam

Field cage  
 $E \sim 1\text{kV/cm/atm}$

逆運動学陽子/重陽子非弾性散乱測定

Proton/Deuteron

0.1 – 1MeV

15 - 25cm

20 – 90 deg

$^{132}\text{Xe}$   
数100MeV/u

H<sub>2</sub>/D<sub>2</sub> gas 40kPa

### Development to increase luminosity and statistics

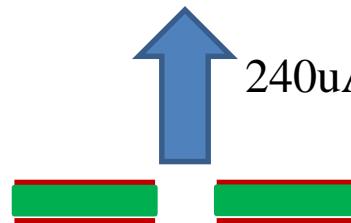
- High intensity beam: 1MHz
- Active region of TPC: 30 cm × 30 cm

# Point of the development for GEM

- 大強度重イオンビームの照射 → 電離電子数の増加
  - $\sim 120\text{fC} / 300\text{mm with } 1\text{MHz}$  of  $^{132}\text{Xe}$  beam  $185\text{MeV/u}$  in  $\text{H}_2$  gas  $40\text{kPa}$ 
    - Induction region における大電流

Gain = 2000 (反跳粒子用設定)のとき

読み出し電極



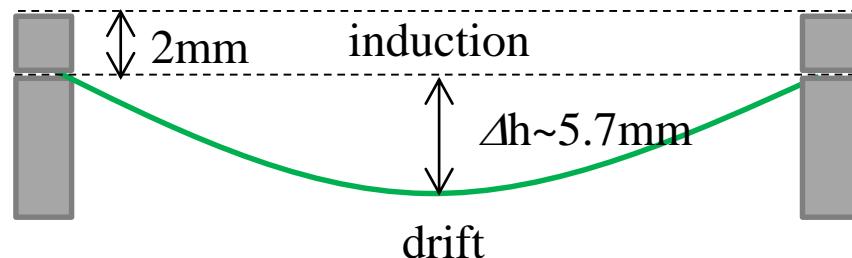
$240\mu\text{A} \rightarrow 24\text{V}$  の電圧降下 → Gain が 0.7倍下がる



保護抵抗( $100\text{k}\Omega$ )

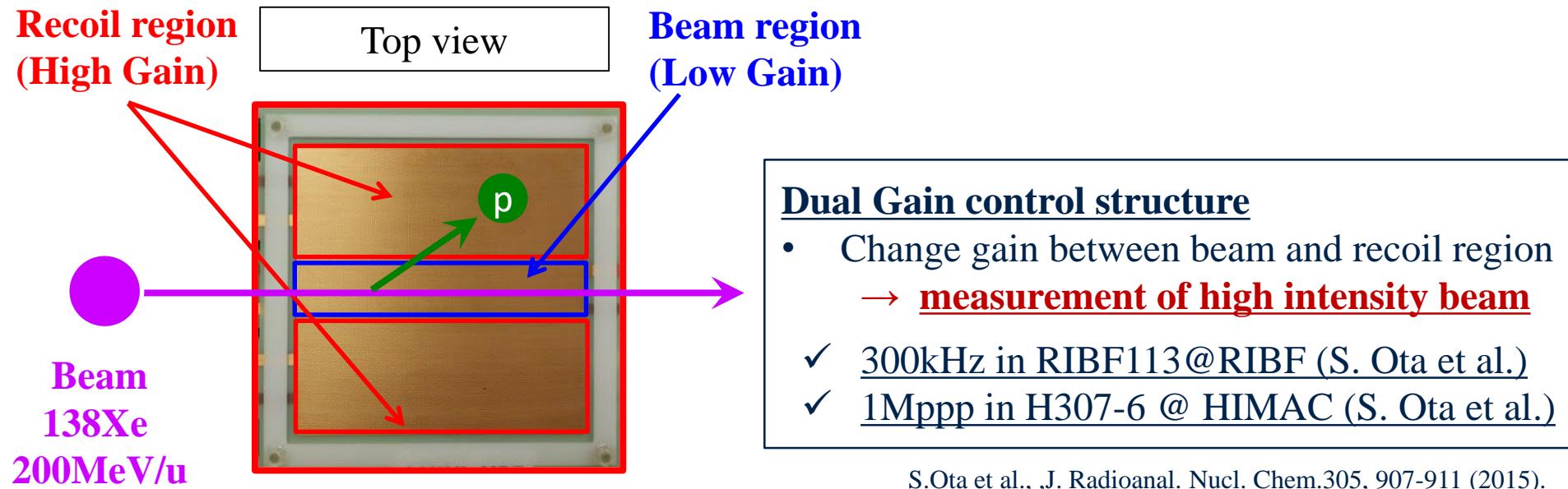
- GEMの面積の拡張 → 自重によるたわみが心配

$300\text{mm} \times 300\text{mm} \times 0.4\text{mmt, FR4 両端支持等分布荷重一次元計算}$



Ex: induction region の電場強度が変化  
→ GEMの中央と端でGain が20%程度変わる

# 二重増幅率制御型 THGEM (Dual Gain THGEM)



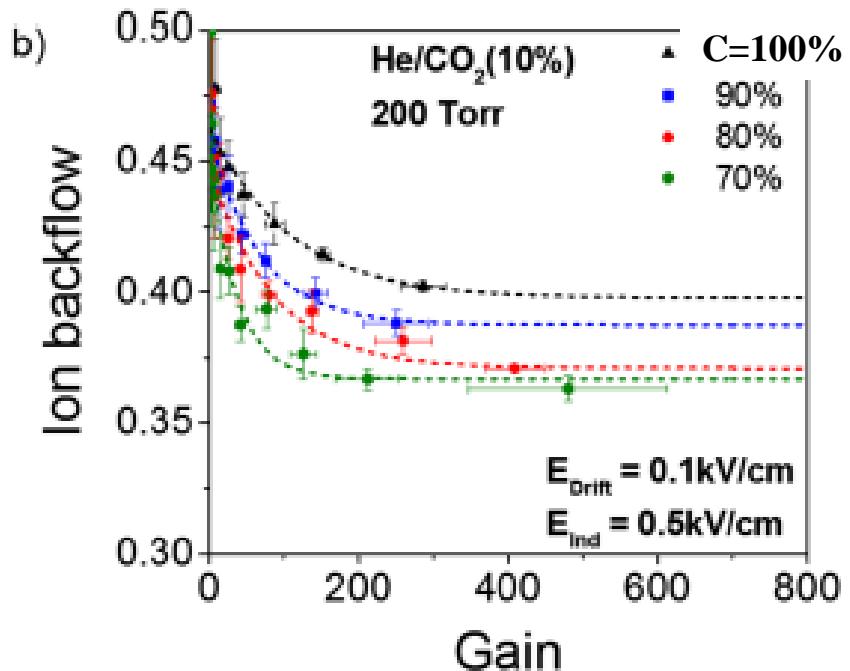
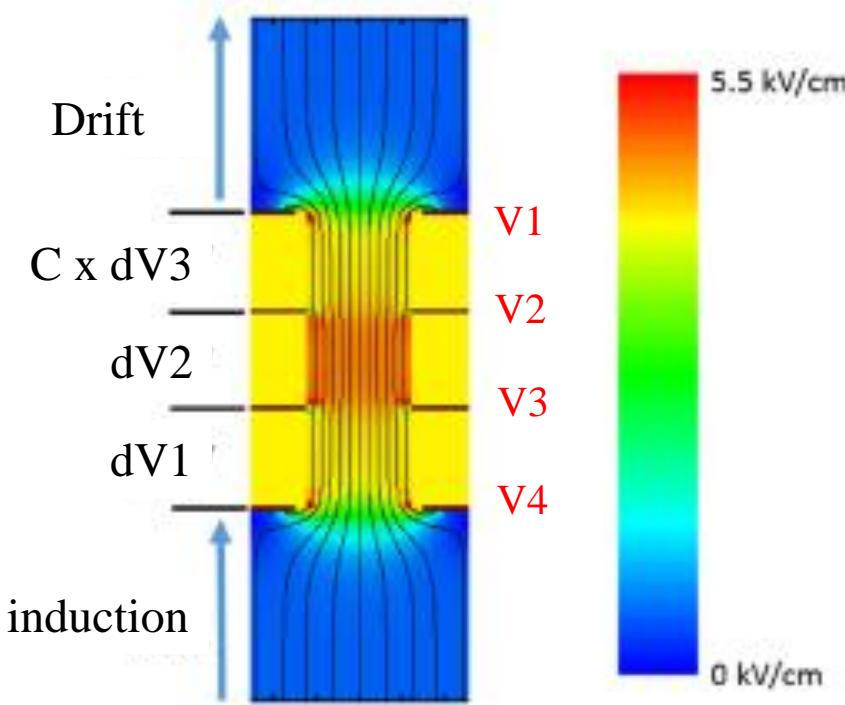
## Requirement (with $\text{H}_2$ gas 40kPa)

- Gain

Gain	$\Delta V_{\text{GEM}}$ [V]	電流 @ Induction [uA]	GEM の電圧降下 [V]
2000	~ 600	240	24
100	~ 500	12	1.2

- Charge resolution
  - Less than 10% ( $\delta\theta_{\text{LAB}} \sim 10\text{mrad}$ )

# 多層 THGEM (Multi-layer THGEM)



## Multi-layer Thick GEM (M-THGEM)

- 厚いので自重でたわみにくい(はず)
- Transfer region がないのでGain を稼げる
- GEM電圧比を変えてion backflow を制御するなどの幅が増える

厚さ [mm]	自重によるたわみ [mm]
0.40	5.7
1.2	0.63

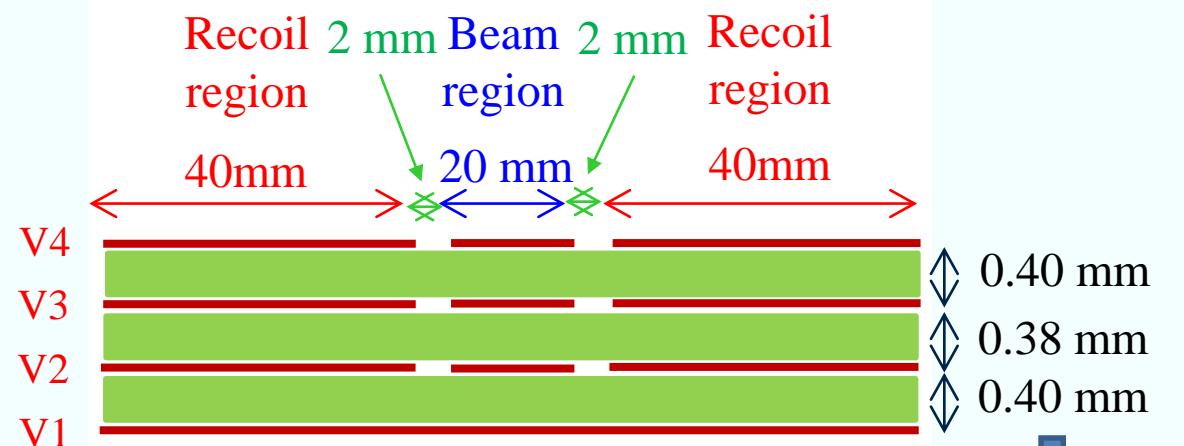
# 目的

## 二重増幅率制御構造 + 多層構造のGEMを作成し性能を評価する

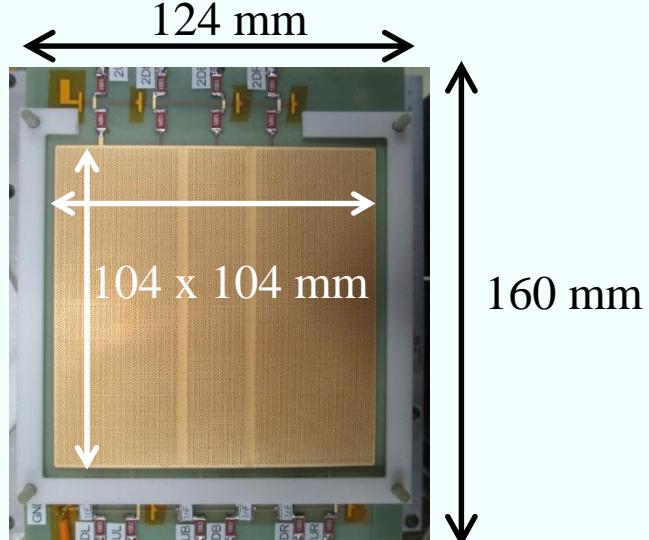
- 大強度重イオンビームに対する性能評価
  - プロトタイプ(10cm x 10cm)を作ってテストした
    - Gain と Charge Resolution の要請を達成できるか？
    - Beam 強度を上げた時にも要請を維持できるか？
- GEMの面積拡張に対する性能評価
  - 30cm x 30cm GEMを実際に作成してテストする
    - (ラフな)たわみ測定
    - (ゲインの一様性測定 (in progress))

# プロトタイプ二重増幅率制御型 THGEM

Side view

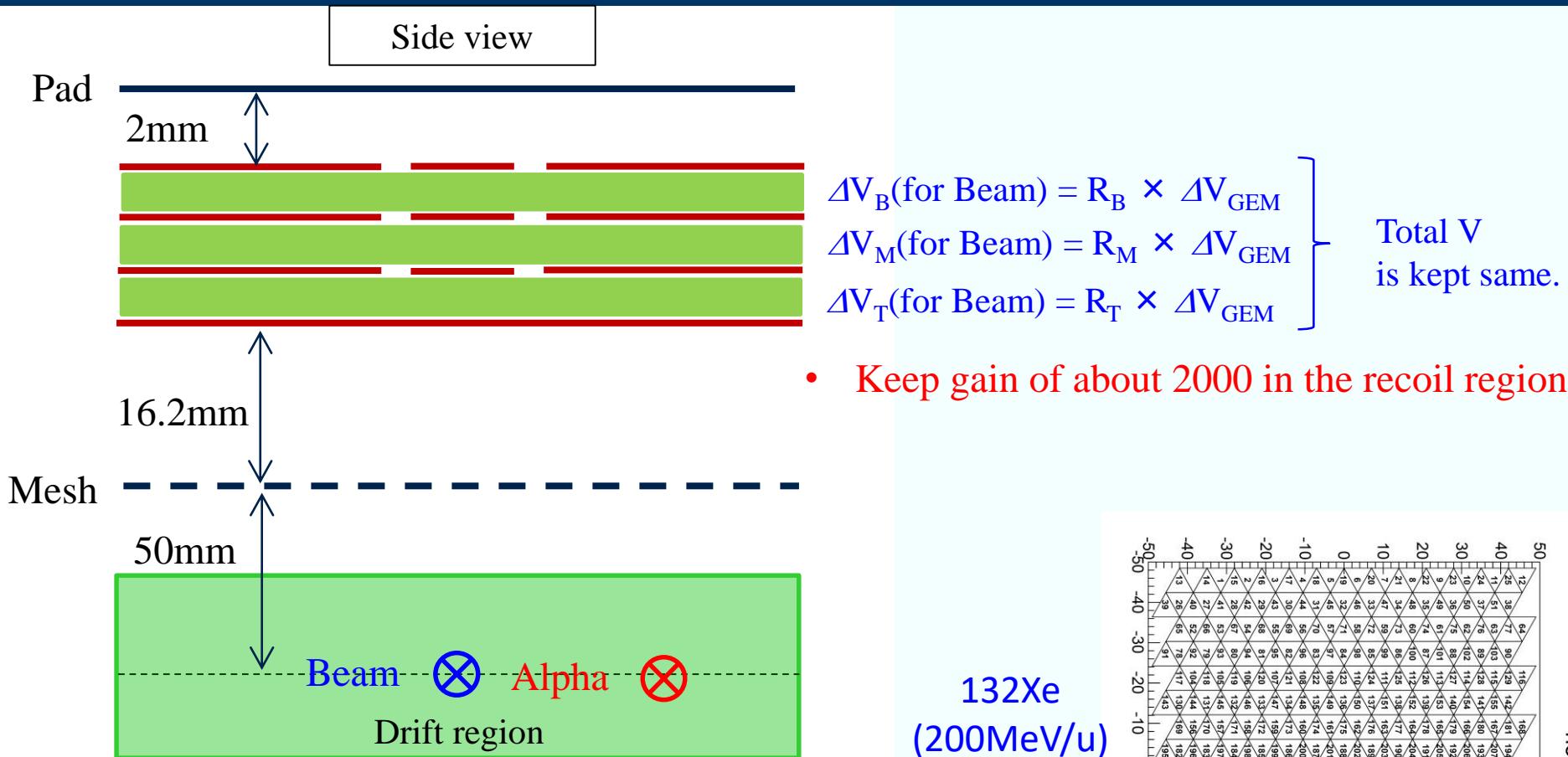


View from drift region



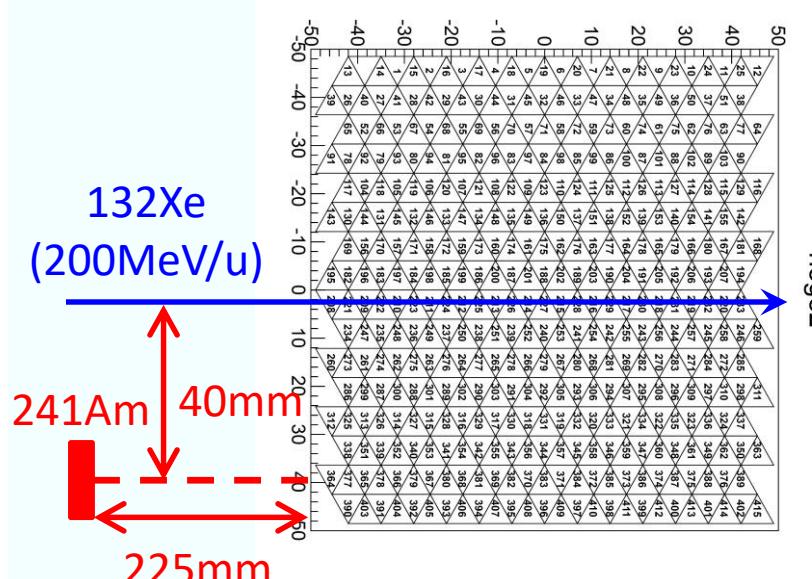
- 製作
  - 林栄精器(株)
- 材質
  - 基盤: FR4
  - 電極: Cu 0.33mm<sup>t</sup>
- Hole size
  - Pitch
    - Z: 0.35 mm
    - X: 0.6062 mm
  - Diameter: 0.3 mm

# プロトタイプ二重増幅率制御型 THGEM の性能評価

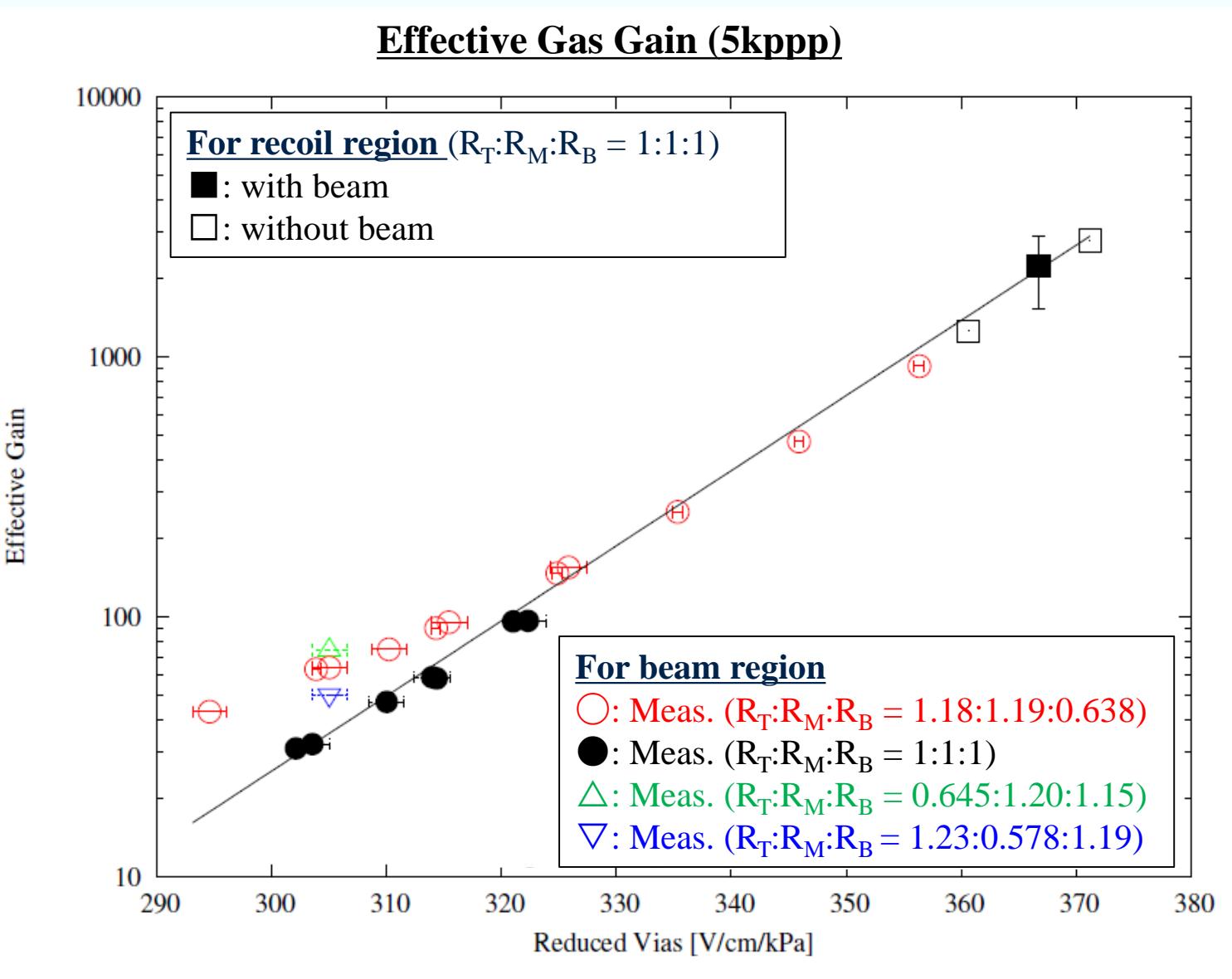


PH2 Beam Line @ 放射線医学総合研究所 HIMAC

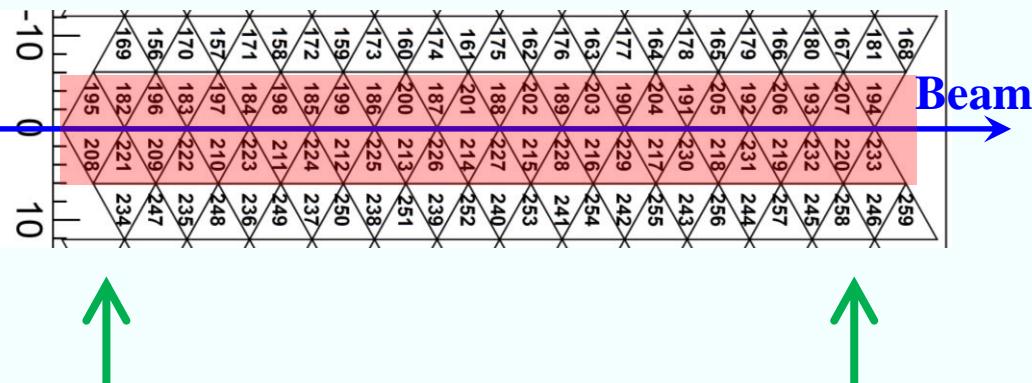
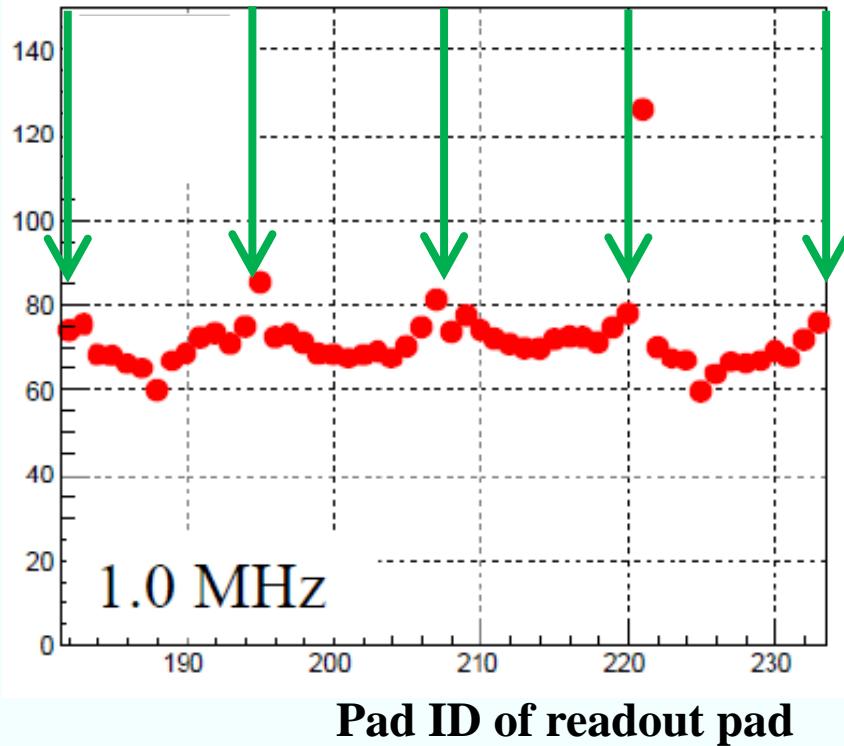
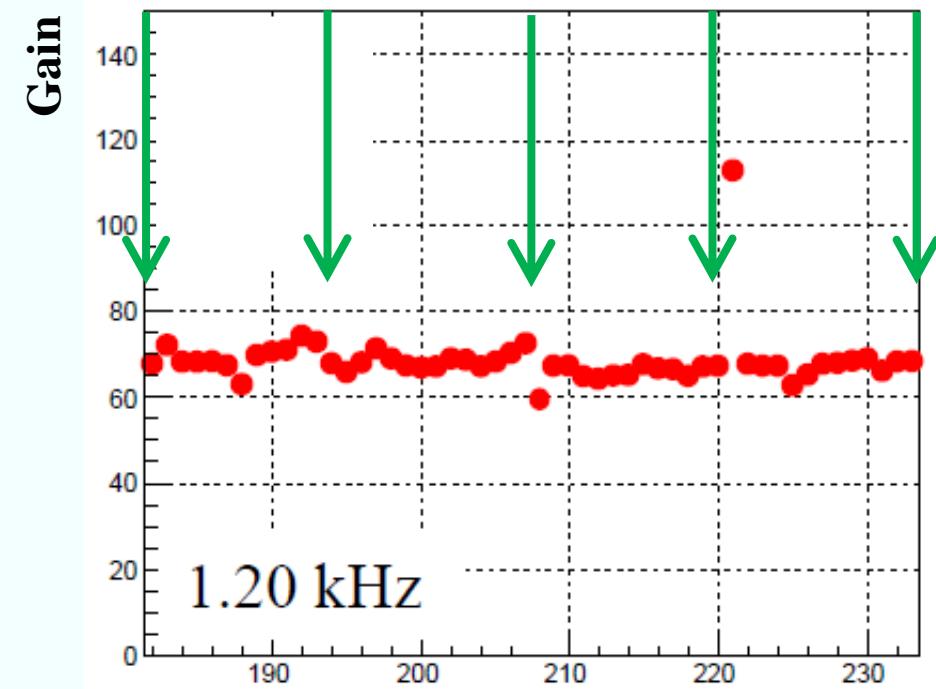
- Beam: 200MeV/u  $^{132}\text{Xe}$ , 5kppp or 1Mppp
  - Beam energy at entrance of CAT:  $\sim 185\text{MeV}$
- Alpha 5.49 MeV from  $^{241}\text{Am}$  source
- Gas: H<sub>2</sub> gas 40kPa



# Gain Curve in the beam region with the low intensity beam

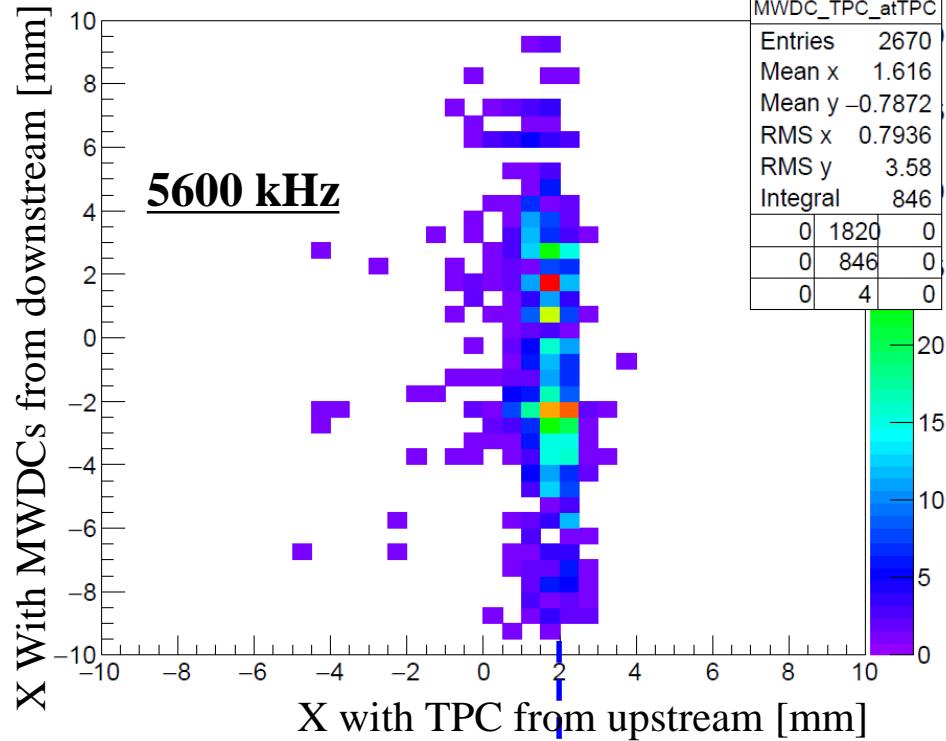
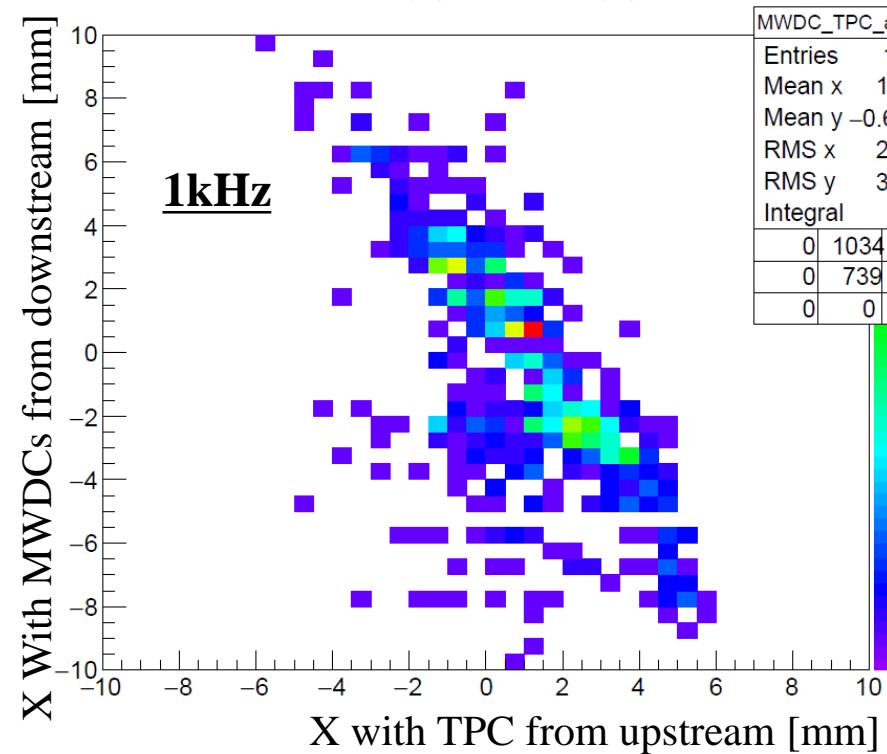


# Gain with the high intensity beam

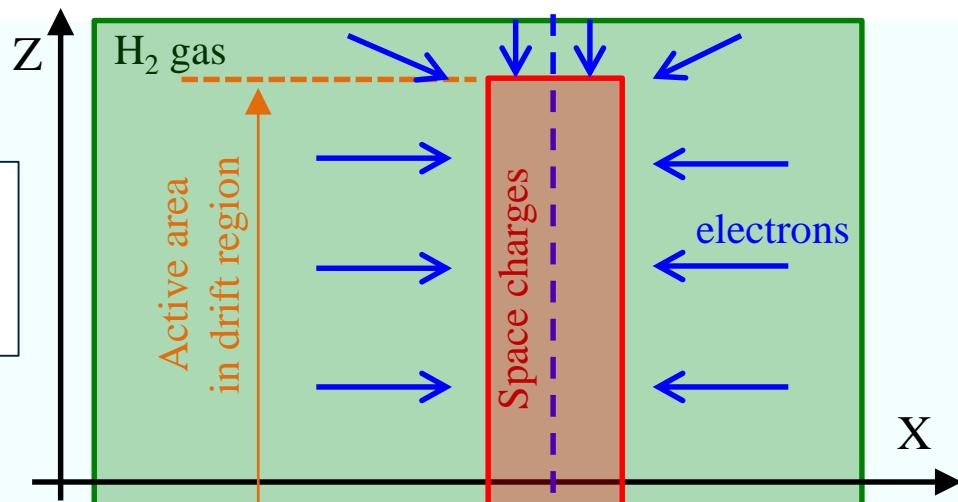


- Not so change from the low intensity beam around the center of the GEM
- ~15% larger than the low intensity beam, at around the edge of beam axis direction on the GEM

# Convergence of X position because of ion backflow

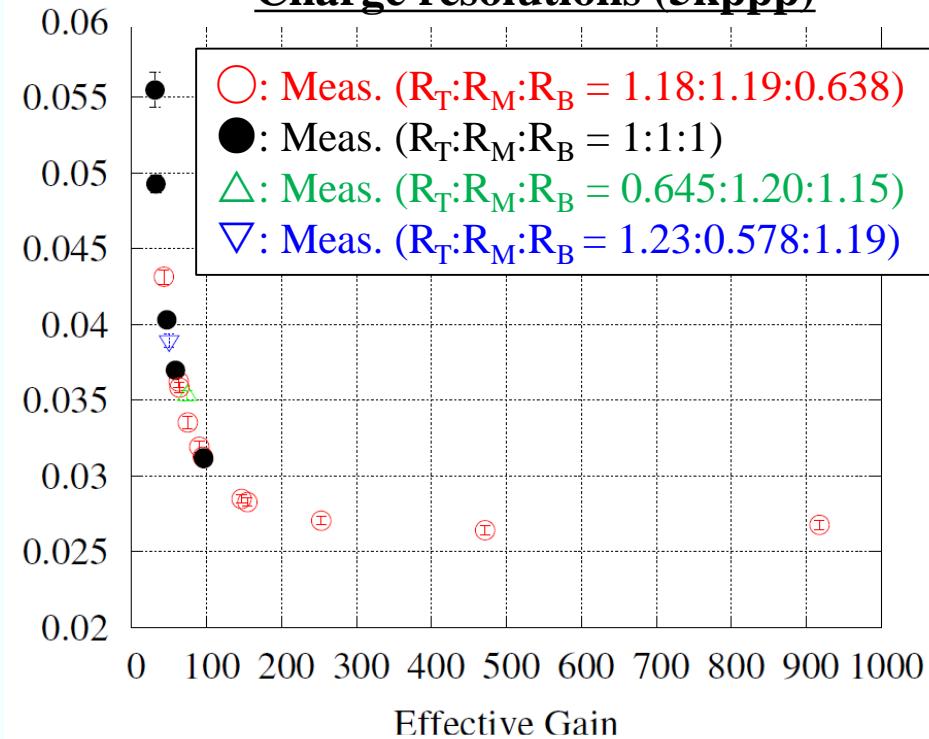


- Space charges by ion backflow converge ionized electrons to beam axis.  
→ Sigma of X with TPC become small.

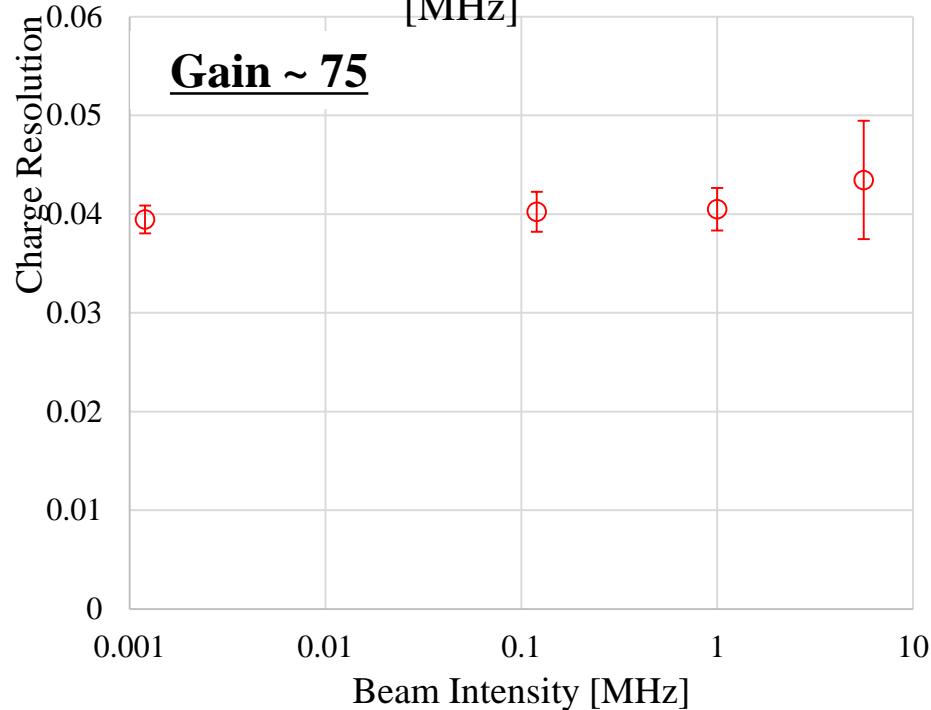


# Charge Resolution in the beam region

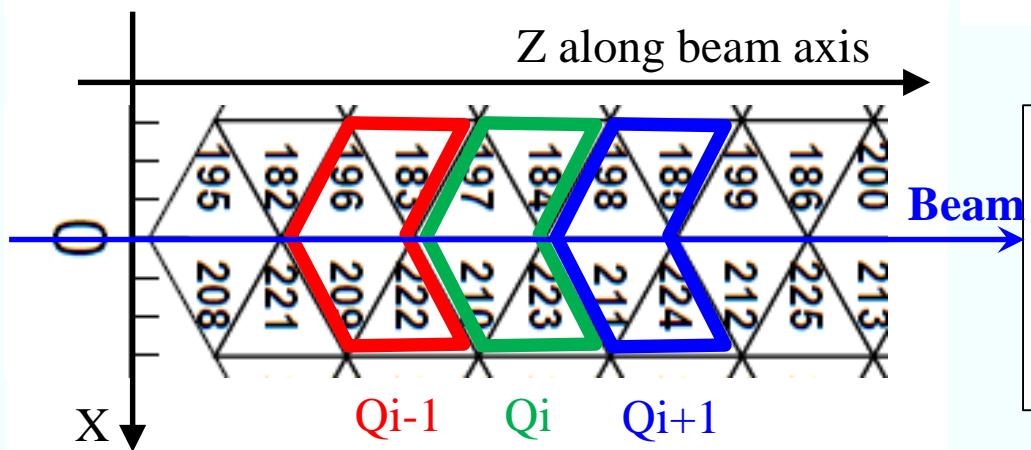
## Charge resolutions (5kppp)



## Charge Resolution vs Beam Intensity [MHz]



Z along beam axis



- Resolution of  $Q_i$  = sigma of  $dQ$   
where,  $dQ = Q_i - \frac{Q_{i-1} + Q_{i+1}}{2}$
- Deposit energy  $\sim 0.65$  keV  
 $\rightarrow$  # of electrons  $\sim 18000$  個

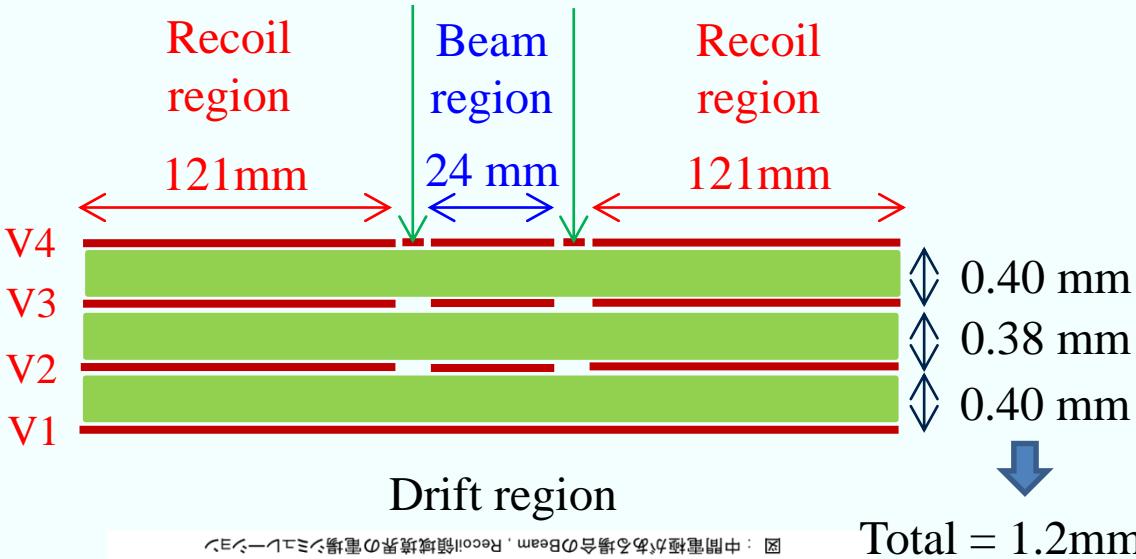
# Dual Gain Multi-Layer THGEM (DG M-THGEM) for CAT-M

製作: 林栄精器(株)

Buffer Region (6 mm)

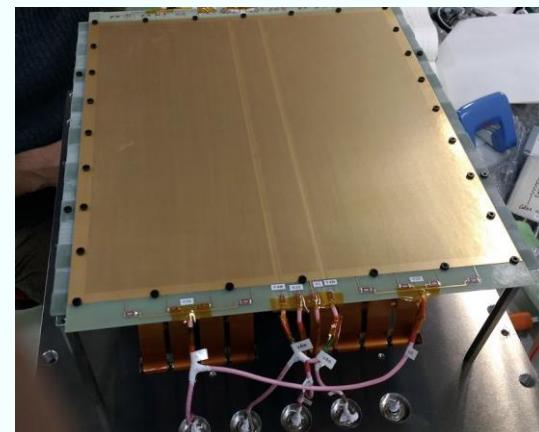
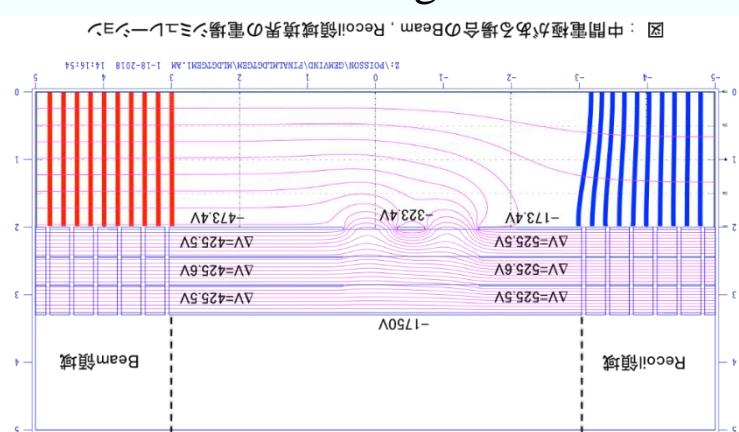
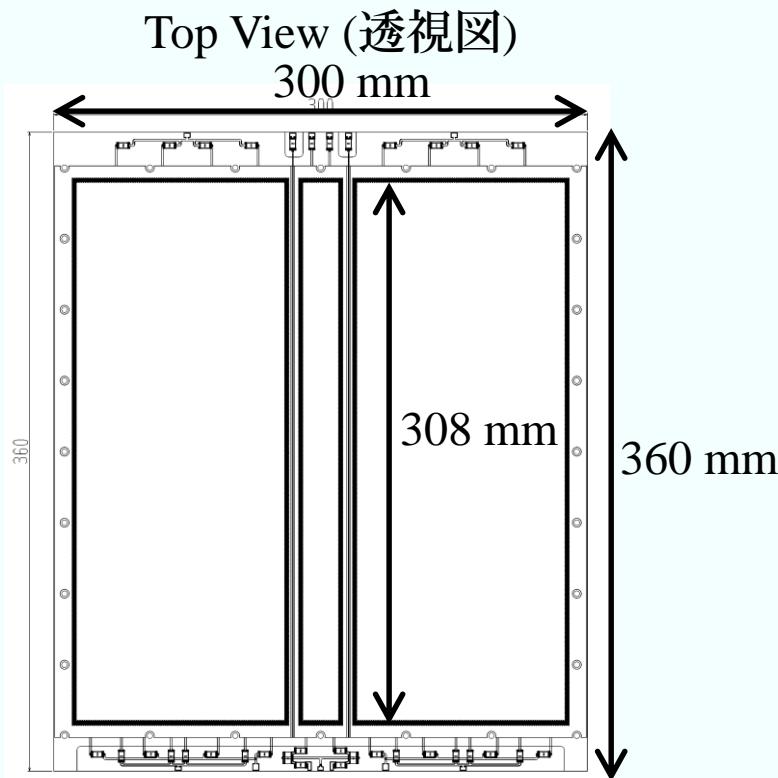
and

Medium Electrode (0.4 mm on V4)



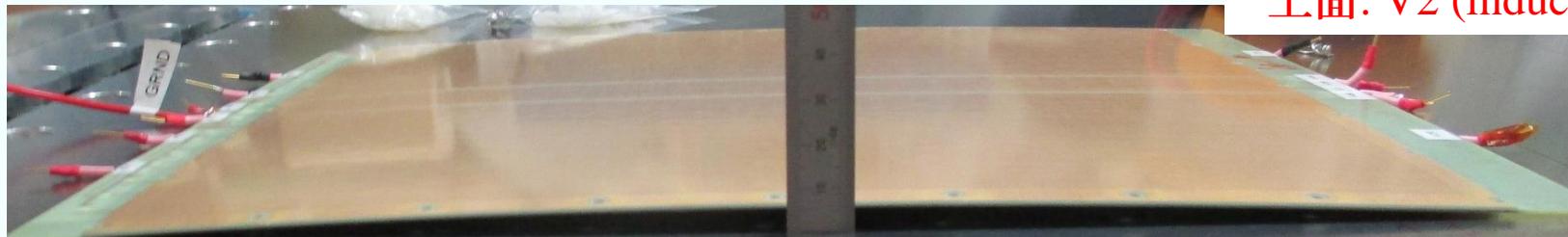
Top View (透視図)

300 mm



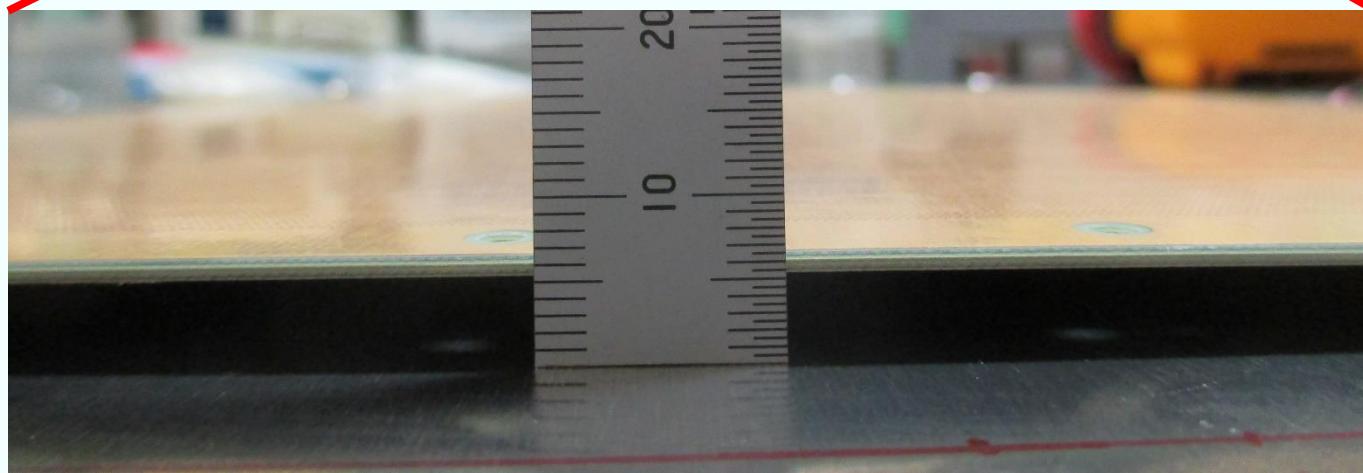
# Bending of the GEM

Beam axis



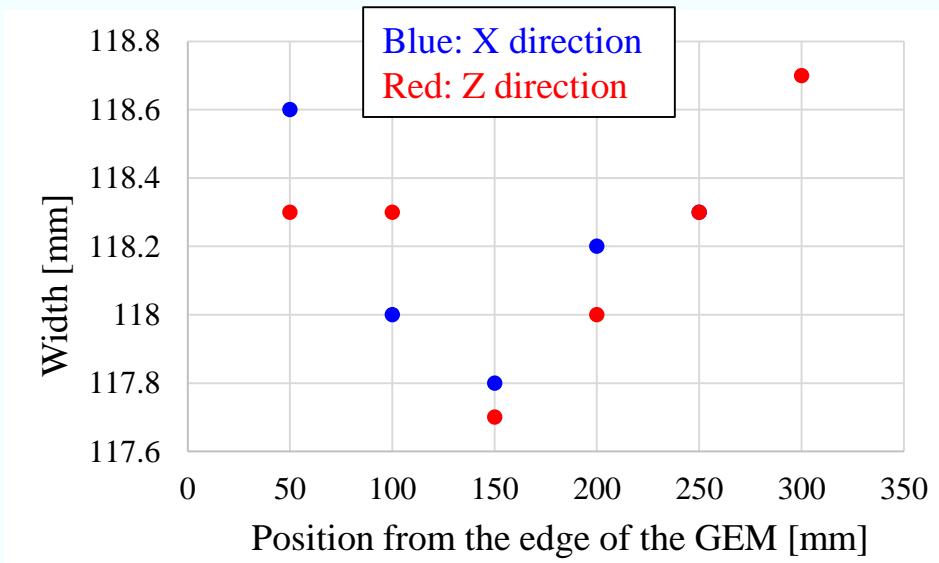
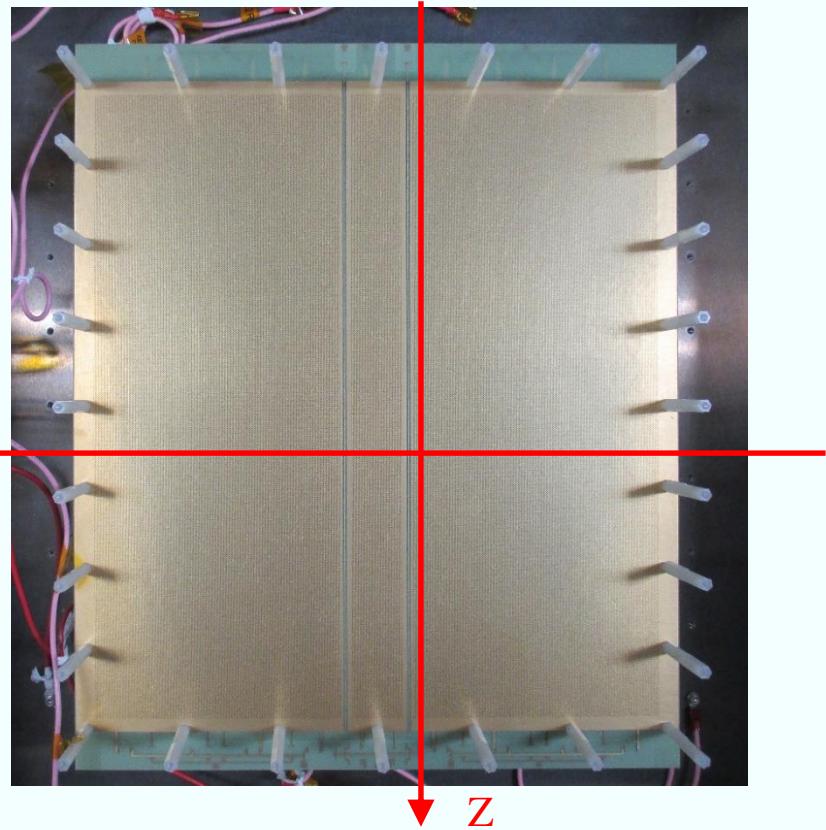
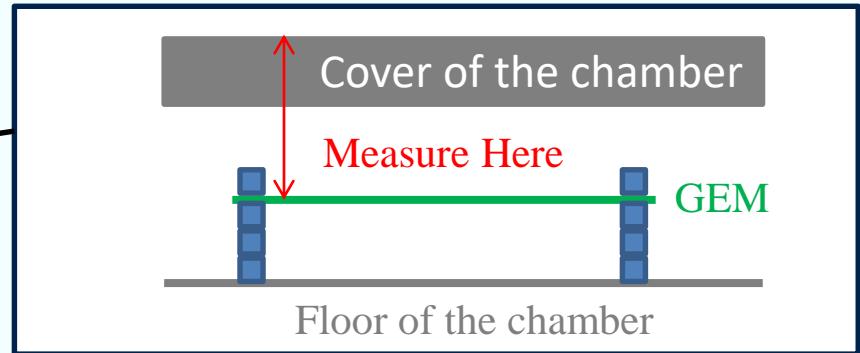
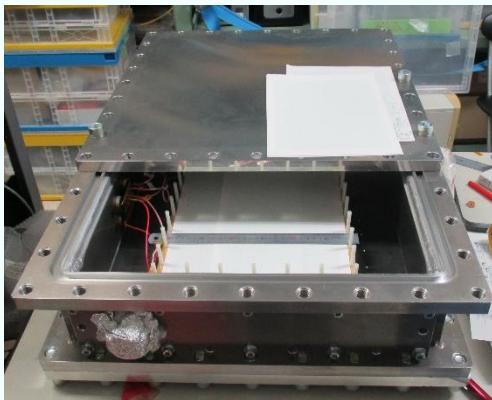
上面: V2 (induction)

下面: V1 (drift)



Maximum bending deflection is about 5 mm if the GEM is not mounted (convex upwards)

# Bending of the mounted GEM



最大で1mm 程度induction region 側にたわむ  
→ Gain 変化 ~ 20% @ induction ~ 2mm

# Summary

- Point of development of GEM for Active target “CAT”
  - Heavy-ion high intensity beam of 1MHz
  - TPC Active region: 30cm x 30cm
- Double Gain Multi-layer THGEM (DG M-THGEM) for CAT-M
  - Dual Gain control system: operating different gain for each region independently
  - Multi-layer THGEM: stack of several THGEM
- Performance of DG M-THGEM with a high intensity beam of  $^{132}\text{Xe}$  200MeV/u
  - Can we achieve previous performance for the beam region?  
→ **OK.**
    - ✓ Gain < 100
    - ✓ Charge Resolution < 6%
  - Can we correctly perform track reconstruction with the high intensity beam?  
→ **X position converge to beam axis and charge resolution become wrong above 100kHz**
    - Need to reduce ion-backflow
- Bending deflection of Large DG M-THGEM
  - How about the bending deflection ?  
→ **Maximum bending deflection is about 1mm**
    - Check gain uniformity of Large DG M-THGEM : in progress